LAA120 Dual Single-Pole, Normally Open OptoMOS® Relay

Parameter	Ratings	Units
Blocking Voltage	250	V _P
Load Current	170	mA
Max R _{ON}	20	Ω

Features

- 3750V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- · High Reliability
- · Arc-Free With No Snubbing Circuits
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Small 8-Pin Package
- · Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - · Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

LAA120 is a Dual 1-Form-A Solid State Relay that has two independently controlled, optically coupled MOSFET switches. The MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture to provide $3750V_{rms}$ of input to output isolation. The optically coupled outputs are controlled by highly efficient GaAlAs infrared LEDs. This dual switch OptoMOS relay provides a more compact design solution than discrete single-pole relays in a variety of applications, and saves board space by incorporating both switches in a single 8-pin package.

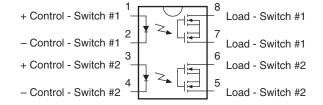
Approvals

- UL Certified Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 10 05 49410 006

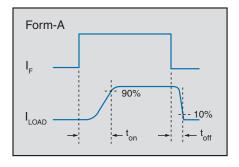
Ordering Information

Part #	Description
LAA120	8-Pin DIP (50/Tube)
LAA120S	8-Pin Surface Mount (50/Tube)
LAA120STR	8-Pin Surface Mount (1,000/Reel)
LAA120P	8-Pin Flat Pack (50/Tube)
LAA120PTR	8-Pin Flat Pack (1,000/Reel)

Pin Configuration



Switching Characteristics of Normally Open (Form A) Devices











Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	250	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation Voltage, Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

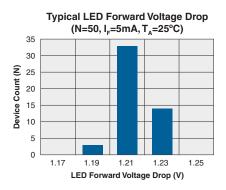
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics	,					
Load Current						
Continuous ¹	-	IL	-	-	170	- mA
Peak	t = 10ms	I _{LPK}	-	-	400	
On-Resistance ²	I _L =170mA	R _{ON}	-	15	20	Ω
Off-State Leakage Current	V _L =250V _P	I _{LEAK}	-	-	1	μΑ
Switching Speeds						
Turn-On	I -5mA \/ -10\/	t _{on}	-	-	5	ms
Turn-Off	I _F =5mA, V _L =10V	t _{off}	-	-	5	1115
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	50	-	pF
Input Characteristics						
Input Control Current	I _L =170mA	I _F	-	-	5	mA
Input Dropout Current	-	-	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μΑ
Common Characteristics						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

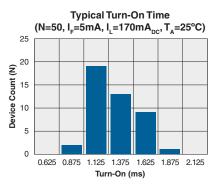
¹ If both poles operate, then the load current must be derated so that it does not exceed the package power dissipation value.
2 Measurement taken within 1 second of on-time.

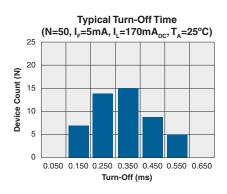
² Derate linearly 6.67 mW / °C

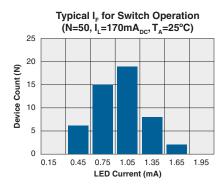


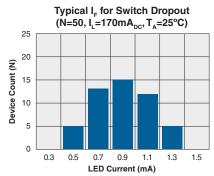
PERFORMANCE DATA*

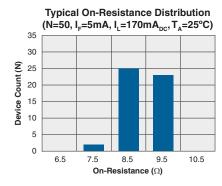


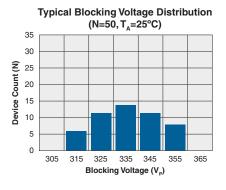


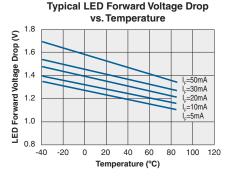


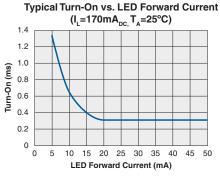


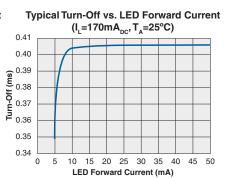








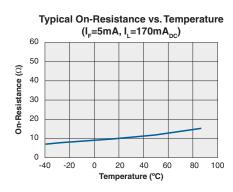


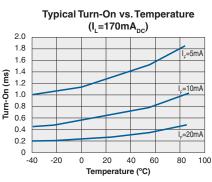


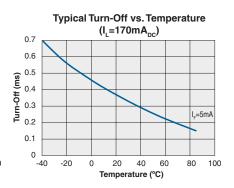
^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

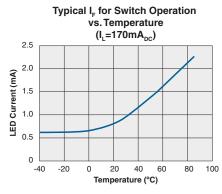


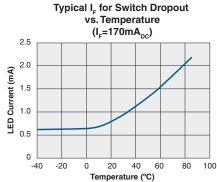
PERFORMANCE DATA*

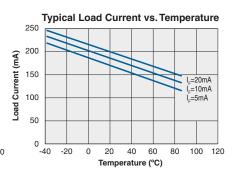


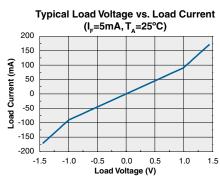


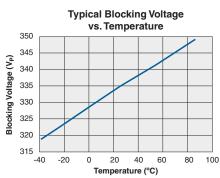


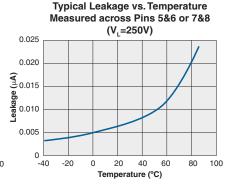


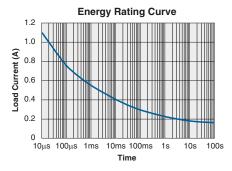












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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to

the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
LAA120 / LAA120S / LAA120P	MSL 1

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time		
LAA120 / LAA120S	250°C for 30 seconds		
LAA120P	260°C for 30 seconds		

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake may be necessary if a wash is used after solder reflow processes. Chlorine-based or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



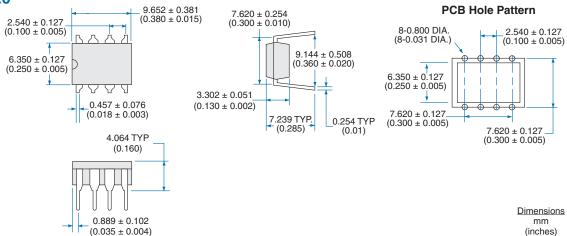




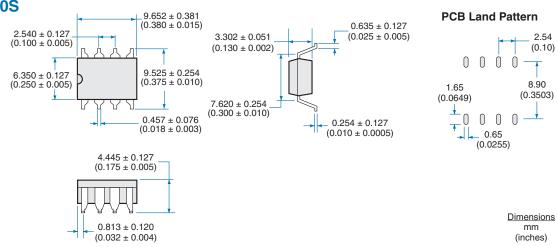


MECHANICAL DIMENSIONS

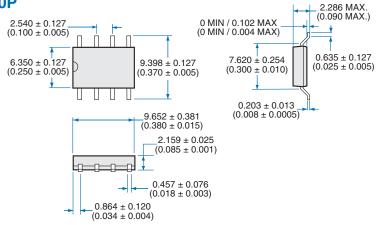
LAA120



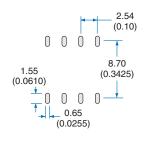
LAA120S



LAA120P



PCB Land Pattern

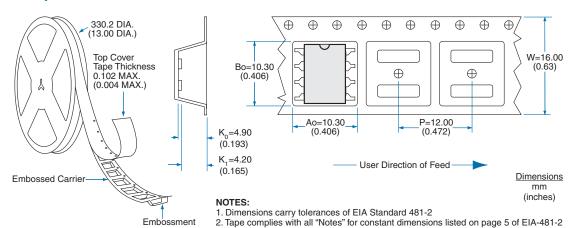


Dimensions mm (inches)

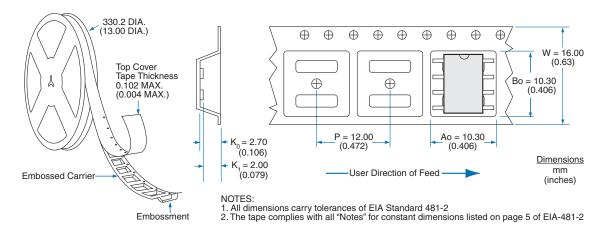


MECHANICAL DIMENSIONS

LAA120S Tape & Reel



LAA120P Tape & Reel



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